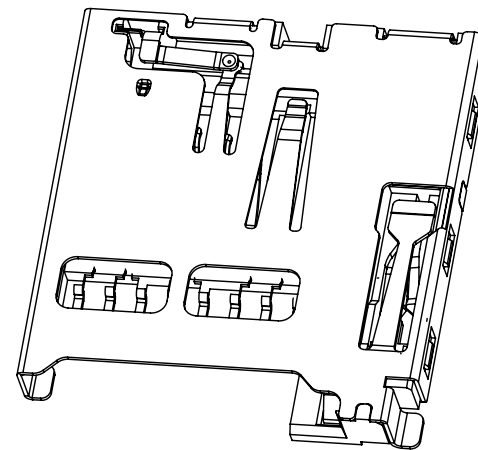
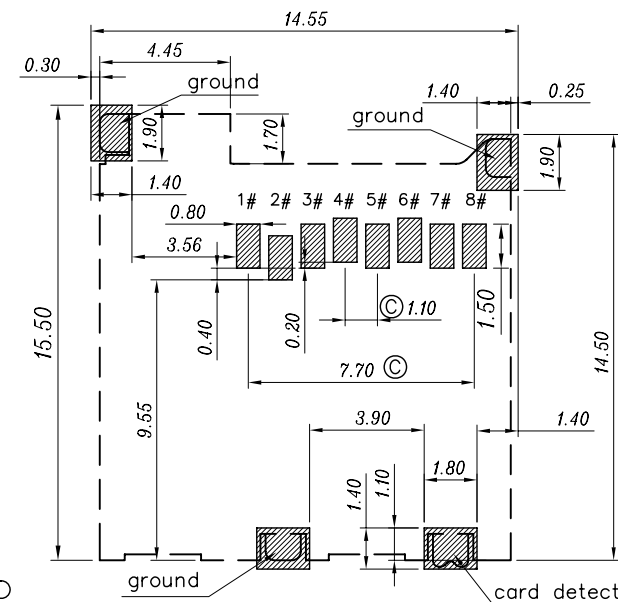
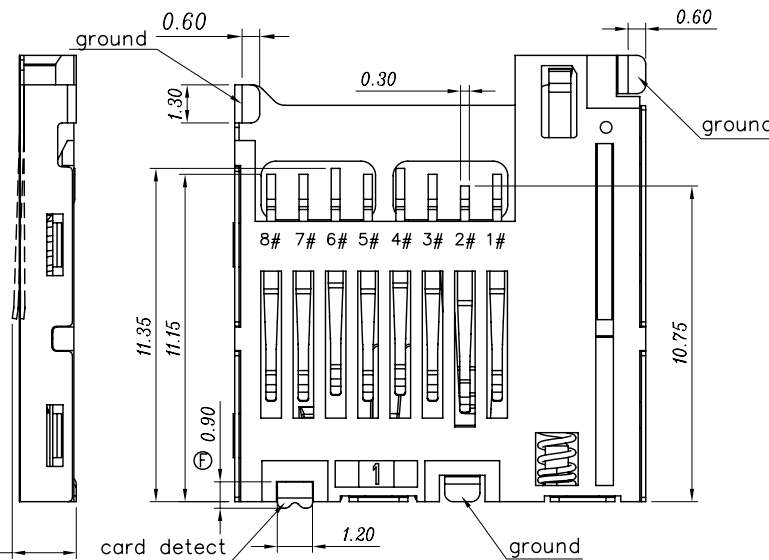




Notes:

- 1.All Dimensions are in Millimeters.
- 2.Material:
 - Housing:LCP Color:black
 - Contact:Phosphor Bronze.
 - Tin 160u" at Solder Tail,
 - Selected Gold on Contact Area Plating.
- 3.Specification:
 - 3.1.Electrical Characteristics:
 - 3.1.0. Contact Resistance: 100mΩ Max.
 - 3.1.1. Dielectric Withstanding Voltage:
 - 500VAC Max With i Minute
 - 3.1.2. Insulation Resistance:1000 MΩ Min.
 - 3.1.3. Current Rating: 0.5A AC/DC Max.
 - 3.2.Mechanical Characteristics:
 - 3.2.0. Mating Force: 30N Max.
 - 3.2.1. Unmating Force : 1~30N.
 - 3.2.2. Contact Retation Force:
 - 100g Min. Per Pin.
 - 3.2.3. Operating Temperature: -25℃~+85℃
 - 3.2.4. Storage Temperature: -40℃~+85℃
4. 本产品的环境物质含量符合欧盟RoHS指令, ASMI的产品与材料/环境物质限制管制规范 (WI-QA-002(1)/(2)) 最新版本及最终客户要求。



CD CONTACT GROUND

Detec state initial

CD CONTACT GROUND gr

Detect state inserting Card

RECOMMENDED PCB LAYOUT
(ALL TOLERANCE IS 0.05)
STEEL BOARD T=0.12MM(MIN)

GENERAL TOLERANCE		FILE.NO.	10100660	PART.NO.	10100660***	DRAWN	Jimmy.Deng	MATERIAL		SCALE	4:1
X.±0.50	x. ± 5°	REV.	G	TITLE	microSD push push connector(9Pin)-II	CHECKED		DATE	10/10/2012	UNIT	MM
.X±0.38	.x ± 2°	SIZE		SHEET	1 OF 1	APPROVED		Amphenol Shouh Min Industry			
.XX±0.25	.xx± 1°	A4									

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